PXIe-5622

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PXIe-5622 Specifications

These specifications apply to the PXIe-5622 with 64 MB and 256 MB of memory.

Hot Surface If the PXIe-5622 has been in use, it may exceed safe handling temperatures and cause burns. Allow the PXIe-5622 to cool before removing it from the chassis.

Caution Do not operate the PXIe-5622 in a manner not specified in this document. Product misuse can result in a hazard. You can compromise the safety protection built into the product if the product is damaged in any way. If the product is damaged, return it to NI for repair.

Definitions and Conditions

Specifications are subject to change without notice. For the most recent PXIe-5622 specifications, visit ni.com/manuals. Unless otherwise noted, the following conditions were used for each specification:

- Direct path filter setting enabled
- Sample clock set to internal 150 MS/s, unlocked
- 1 V vertical range

Specifications describe the warranted, traceable performance of the device over an ambient temperature range of 0 °C to 55 °C and include guardband for measurement uncertainty, unless otherwise noted. Specifications are valid under the following conditions unless otherwise noted:

- The PXIe-5622 module is warmed up for 15 minutes at ambient temperature.
- Calibration cycle is maintained.
- NI-SCOPE self-calibration performed after device temperature is stable.

- The PXI Express chassis fan speed is set to HIGH, the foam fan filters are removed if present, and the empty slots contain PXI chassis slot blockers and filler panels. For more information about cooling, refer to the **Maintain** Forced-Air Cooling Note to Users available at <u>ni.com/manuals</u>.
- External calibration is performed at 23 °C ± 3 °C.

Typical Specifications are unwarranted values that describe the expected performance of the device over ambient temperature ranges of 23 °C \pm 5 °C with a 90% confidence level.

Characteristics (or supplemental information) describe basic functions and attributes of the device established by design.

Data in this document are Specifications unless otherwise noted.

To access PXIe-5622 documentation, including the **PXIe-5622 Getting Started Guide**, go to **Start** » **All Programs** » **National Instruments** » **NI-SCOPE** » **NI-SCOPE Documentation**.

Vertical

Analog Input (IF IN)

Number of channels	One (IF IN)
Input impedance	50Ω , characteristic
Input return loss	<-15 dB, 5 MHz to 300 MHz, typical
Input coupling	AC, GND
Full scale (FS) input voltage range (Vpk-pk)[1]	0.7 V (+1 dBm), 1 V (+4 dBm), 1.4 V (+7 dBm)
Maximum voltage input overload (Vpk-pk)	6.3 V (+20 dBm)

Accuracy

Resolution 16-bit

Absolute amplitude accuracy, at center frequency of specified bands, valid for all input ranges^[2]

Bandpass Path (187.5 MHz) <±0.5 dB

Direct Path (53 MHz) <±0.4 dB

Absolute amplitude accuracy, at center frequency of specified bands, valid for all input ranges^[3]

Bandpass Path (187.5 MHz) <±0.3 dB, typical

Direct Path (53 MHz) <±0.25 dB, typical

Temperature stability, maximum drift of ±2 °C from last self-calibration, valid for all input ranges

Bandpass Path (187.5 MHz) <0.01 dB/°C

Direct Path (53 MHz) <0.02 dB/°C

Absolute Amplitude Accuracy Examples at 40 °C in the Bandpass Path

Amplitude accuracy specification: $0.5 + 0.01 \times (40 - 23) = \pm 0.67 \text{ dB}$

Amplitude accuracy, typical: $0.3 + 0.01 \times (40 - 23) = \pm 0.47 \text{ dB}$

Bandwidth and Frequency Response

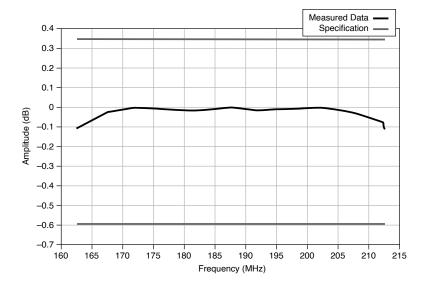
Bandwidth (-3 dB), bandwidth of unequalized response

Bandpass path (187.5 MHz) 50 MHz, centered at 187.5 MHz, 3rd Nyquist zone, typical

Direct path (53 MHz) 3 MHz to 250 MHz, typical

Dither signal, frequency range [4] 100 kHz to 12 MHz, typical

Figure 1. Equalized Amplitude Response (Bandpass Path), Using Calibration Data



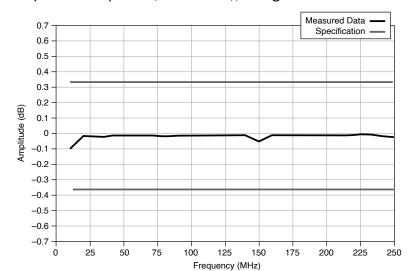
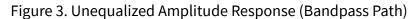
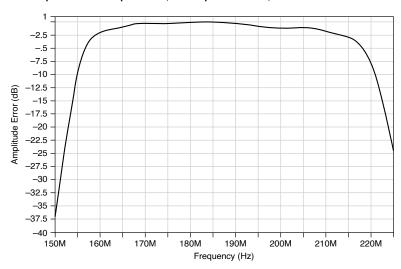
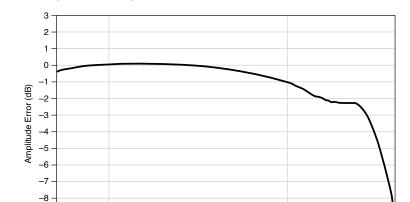


Figure 2. Equalized Amplitude Response (Direct Path), Using Calibration Data

Note The Direct Path Equalized Amplitude Response shown above is a composite plot of multiple segments of 40 MHz span each.







100

400

Figure 4. Unequalized Amplitude Response (Direct Path)

-9 --10 -

10

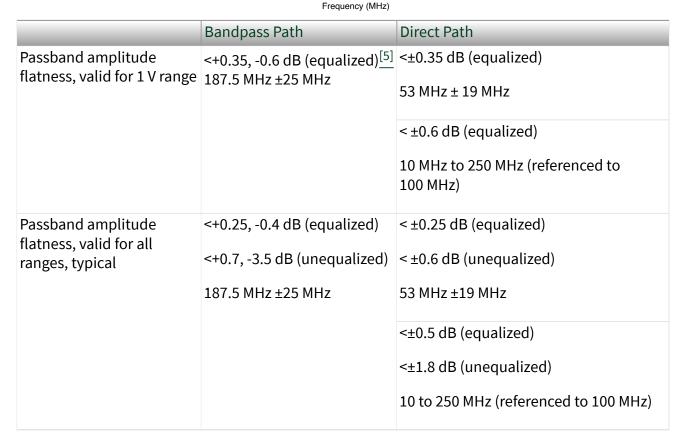


Table 1. Passband Amplitude Flatness

Bandwidth	Bandpass Path Phase	Direct Path Phase
10 MHz	±0.5°	±0.5°

Bandwidth	Bandpass Path Phase	Direct Path Phase
20 MHz	±1°	±1°
40 MHz	±1.75°	n/a
50 MHz	±2.5°	

Table 2. Passband phase linearity, valid for all input ranges, after equalization, typical

Spectral Characteristics^[6]

Spurious-free dynamic range with harmonics (SFDR), for input signal with levels from -1 dBFS to -10 dBFS

Bandpass path (187.5 MHz) <-76.5 dBc, typical

Direct path (53 MHz) <-73 dBc, typical

Total harmonic distortion (THD), includes 2nd through 5th harmonics

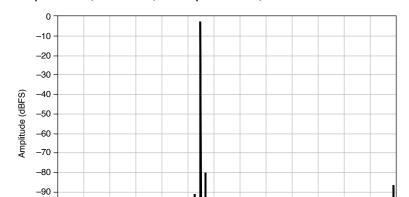
Bandpass path (187.5 MHz) <-76 dBc, typical

Direct path (53 MHz) <-71 dBc, typical

Intermodulation distortion (IMD), two tones 1 MHz apart, down to -10 dBFS level

Bandpass path (187.5 MHz) <-74 dBc, typical

Direct path (53 MHz) <-73 dBc, typical



185 190 195 200

Frequency (MHz)

205 210 215

220

Figure 5. Single Tone Spectrum, 5.5 dBm, Bandpass Path, 4 kHz RBW

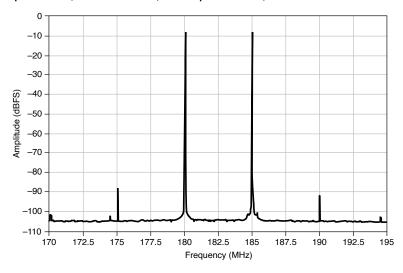
Figure 6. Two-Tone Spectrum, 2 dBm Each, Bandpass Path, 4 kHz RBW

170

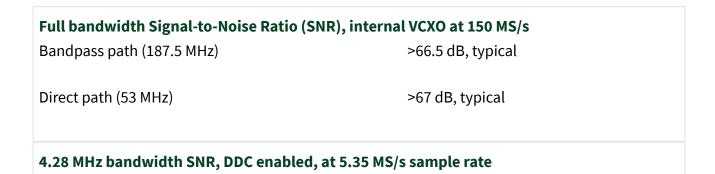
175 180

-100 -

160 165



Noise



Bandpass path (187.5 MHz)	>71.5 dB, typical
_ =	1 = 10 0 = 1 0 0 0 0 0 0 0 0 0 0

3 dB, typical
5 (

	Bandwidth	Bandpass path (187.5 MHz)	Direct path (53 MHz)
SSB phase noise	100 Hz	<-80 dBc/Hz	<-90 dBc/Hz
	1 kHz	<-117 dBc/Hz	<-128 dBc/Hz
	10 kHz and above	<-134 dBc/Hz	<-141 dBc/Hz
SSB phase noise, typical	100 Hz	<-83 dBc/Hz	<-94 dBc/Hz
	1 kHz	<-120 dBc/Hz	<-132 dBc/Hz
	10 kHz and above	<-140 dBc/Hz	<-144 dBc/Hz

Table 3. SSB Phase Noise, Internal VCXO, Unlocked

	Range	Value
Average noise density ^[7]	0.7 V/+1 dBm	<-146 dBm/Hz
	1 V/+4 dBm	<-143 dBm/Hz
	1.4 V/+7 dBm	<-140 dBm/Hz
Average noise density, typical ^[8]	0.7 V/+1 dBm	<-149 dBm/Hz
	1 V/+4 dBm	<-146 dBm/Hz
	1.4 V/+7 dBm	<-143 dBm/Hz

Table 4. Average noise density

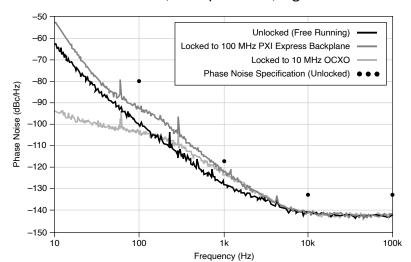
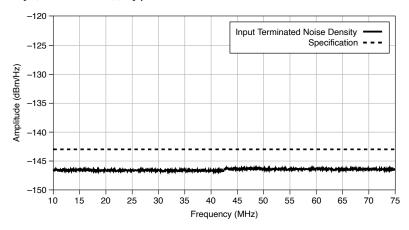


Figure 7. Measured Phase Noise at 187 MHz, Bandpass Path, Signal Level = 3 dBm, Typical

Figure 8. Noise Density (Direct Path), Typical



Horizontal

Sample Clock

Sample clock sources

Internal VCXO (can be free running or locked to a reference clock)

External CLK IN (front panel connector)

Onboard Clock (Internal VCXO)

Sample rate ^[9]	150 MS/s with decimation by N
Accuracy	±5.0 × 10 ⁻⁶ , typical
Accuracy over temperature	$\pm 12 \times 10^{-6}$, typical
SSB phase noise of 150 MHz Sample Clock when exported to CLK OUT[10]	
100 Hz	<-90 dBc/Hz, typical
1 kHz	<-130 dBc/Hz, typical
10 kHz	<-140 dBc/Hz, typical
100 kHz and above	<-150 dBc/Hz, typical

Phase-Locked Loop (PLL) External Reference Clock

Reference Clock sources (used to phase lock onboard VCXO)	CLK IN (front panel connector), PXIe 100 MHz (PXIe backplane)
Sample Clock delay range (delay relative to Reference Clock when VCXO is locked)	±1 Sample Clock period
Sample Clock delay resolution (delay relative to Reference Clock when VCXO is locked)	≤4 ps
Reference Clock frequency range	1 MHz to 100 MHz, in 1 MHz increments
Reference Clock frequency accuracy $\boxed{^{[11]}}$	±25 × 10 ⁻⁶

Reference Clock duty cycle tolerance	45% to 55%, typical
Reference Clock export ports	CLK OUT (front panel connector)

External Sample Clock

Frequency range	20 MHz to 150 MHz
Duty cycle tolerance	45% to 55%, typical
Export ports	CLK OUT (front panel connector)

CLK IN (Sample Clock and Reference Clock Input, Front Panel Connector)

nput impedance		50 Ω, typical
Coupling		AC
Amplitude		
Sine wave (Vpk-pk)	0.63 V to 2.8 V (0 to +13	dBm)
Square wave (Vpk-pk)	0.25 V to 2.8 V	
Maximum input overload (Vpk-pk)		6.3 V (+20 dBm)

CLK OUT (Sample Clock and Reference Clock Output, Front Panel Connector)

Output impedance	50Ω , typical
Coupling	AC
Amplitude	
50 Ω load	>+10 dBm, typical
1 kΩ load, square wave (Vpk-pk)	> 2 V, typical

PFI 1 (Programmable Function Interface)

PFI 1 (programmable function interface) direction	Bi-directional

Trigger

Trigger types		Digital
As an input (trigger) Destinations	Start Trig	ger (Acquisition Arm)
	Reference	e (Stop) Trigger
	Arm Refe	rence Trigger
	Advance	Trigger
Input impedance	150 kΩ, c	haracteristic

Range 0 to 5 V, TTL compatible

Maximum input overload -3.5 V to +8 V, continuous

Maximum frequency 20 MHz

Minimum trigger width >25 ns

As an output (event)

Sources Start Trigger (Acquisition Arm)

Reference (Stop) Trigger

End of Record

Done (End of Acquisition)

Output impedance 50Ω , characteristic

Logic type 3.3 V LVTTL

Maximum drive current ±12 mA

Maximum frequency 25 MHz

TClk Specifications

You can use the NI TClk synchronization method and the NI-TClk driver to align the Sample clocks on any number of supported devices, in one or more chassis. For more information about TClk synchronization, refer to the **NI-TClk Synchronization Help**, which is located within the **NI High-Speed Digitizers Help**. For other configurations, including multichassis systems, contact NI Technical Support at ni.com/support.

PXIe-5622 TClk Specifications

- Specifications measured in an NI PXIe-1062Q chassis.
- All parameters set to identical values for each PXIe-5622.
- Sample Clock set to 150 MS/s and all filters are disabled.

Note Although you can use NI-TClk to synchronize non-identical devices, these specifications apply only to synchronizing identical devices.

Intermodule synchronization using NI-TClk for identical devices

Skew (caused by clock and analog path delay differences; no manual adjustment performed)

≤500 ps, typical

Average skew after manual adjustment [12]

≤4 ps, typical

Sample Clock delay/adjustment resolution

≤4 ps, typical

Waveform Specifications

Onboard memory sizes^[13]

64 MB per channel option 32 megasamples per channel

128 megasamples per channel 256 MB per channel option

Allocated onboard memory per record

(**Record Length** \times 2 bytes/S) + 480 bytes, rounded up to the next multiple of Real data

128 bytes (minimum 512 bytes)^[14]

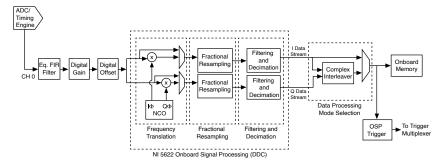
Complex data (Record Length × 4 bytes/S) + 960 bytes, rounded up to the next multiple of

128 bytes (minimum 512 bytes)

Minimum record length	1 sample
Number of pretrigger samples, single-record mode and multiple-record mode	Zero up to full record length
Number of posttrigger samples, single-record mode and multiple-record mode	Zero up to full record length
Maximum number of records in onboard memory $\boxed{^{[15]}}$	100,000

Onboard Signal Processing (OSP)

Figure 9. PXIe-5622 Onboard Signal Processing Block Diagram



Note To use onboard signal processing (OSP) on the PXIe-5622, set the DDC Enabled property/attribute to TRUE.

The following OSP operations are available:

- Send one IF signal to CH 0 and perform quadrature downconversion on the signal (complex data is returned).
- Send a signal to CH 0 and perform alias-protected decimation (real data is returned).
- Send a signal to CH 0 and perform real downconversion on the signal (real data is returned).

Number of digital downconverters (DDCs)	One	
Data processing modes	Real (I path only); Complex (IQ)	
OSP decimation (protects acquired data from high-frequency aliasing within the ADC		

Nyquist zone)^[16]

Range 1, 2, 4, 6, 8, 10

Multiples of 4 range 12 to 4,096

Multiples of 8 range 4,096 to 8,192

Multiples of 16 range 8,192 to 16,384

Fractional resampling enabled 2 to 16,384 to 48 bits of precision

Sample rate range, OSP enabled^[17]

Internal sample clock timebase 9.155 kS/s to 75 MS/s with fractional resampling; or to

150 MS/s without fractional resampling

External sample clock OSP decimation Sample clock timebase/OSP decimation

factor^[18]

Bandwidth^[19]

Real flat bandwidth 0.4 × Sample Rate

Complex flat bandwidth 0.8 × Sample Rate

Complex Flat Bandwidth Example

Complex bandwidth is 60 MHz with a complex sample rate of 75 MS/s.

Using a decimation rate of 1 (sample rate of 150 MS/s with internal clock) bypasses the filters in the OSP block.

OSP Digital Gain and Offset

Digital gain and offset resolution	18 bits
Digital gain range	±1.5 × ADC Data [20]
Digital offset, applied after digital gain	(-0.4 × Vertical Range) to (+0.4 × Vertical Range)
Output ^[21]	(ADC Data × Digital Gain) + Digital Offset

OSP Numerically-Controlled Oscillator (NCO)

Frequency range[22] Internal sample clock timebase	0 MHz to 75 MHz
External sample clock timebase	0 Hz to (0.5 × Sample Clock Timebase)
Frequency resolution	
Internal sample clock timebase	533 nHz
External sample clock timebase	Sample Clock Timebase / 2 ⁴⁸
I and Q phase resolution	0.0055°

OSP Digital Performance

Maximum NCO spur	<-100 dBFS
Decimating filter passband ripple, passband is from 0 to (0.4 × IQ Rate)	< 0.1 dB
Decimating filter Out-of-Band suppression, stopband suppression from (0.6 \times IQ Rate)	> 80 dB

OSP IF Demodulation Typical Performance: Modulation Error Ratio (MER)

	Bandpass path carrier frequency: 187.5 MHz (signal source: NI PXIe-5673)		Direct path carrier frequency: 20 MHz (signal source: NI PXI-5441)	
	Internal Reference Clocks (source and receiver unlocked to any external reference)	PXI chassis Reference Clocks (source and receiver locked to PXIe 100 MHz or PXI 10 MHz chassis backplane clock)	Internal Reference Clocks (source and receiver unlocked to any external reference)	PXI chassis Reference Clocks (source and receiver locked to PXIe 100 MHz or PXI 10 MHz chassis backplane clock)
GSM physical layer, typical. ^[23]	50 dB	59 dB	48 dB	62 dB ^[24]
W-CDMA physical layer, typical. [25]	47 dB	50 dB	39 dB	58 dB
DVB physical layer, typical. [26]	46 dB	48 dB	40 dB	56 dB
20 MSymbols/s QAM, typical. [27]	43 dB	44 dB	37 dB	49 dB
26 MSymbols/s QAM, typical. [28]	39 dB	37 dB	36 dB	40 dB
34 MSymbols/s QAM, typical. [29]	38 dB	37 dB	38 dB	37 dB

Calibration

Self-calibration	Calibrates absolute amplitude accuracy.
External calibration	Calibrates absolute and relative (flatness) amplitude accuracy, VCXO accuracy.
External calibration interval	1 year
Warm-up time	15 minutes

Software

Driver Software

Driver support for this device was first available in NI-SCOPE 3.5.

NI-SCOPE is an IVI-compliant driver that allows you to configure, control, and calibrate the PXIe-5622. NI-SCOPE provides application programming interfaces for many development environments.

Application Software

NI-SCOPE provides programming interfaces, documentation, and examples for the following application development environments:

- LabVIEW
- LabWindows[™]/CVI[™]
- Measurement Studio
- Microsoft Visual C/C++
- .NET (C# and VB.NET)

Interactive Soft Front Panel and Configuration

The NI-SCOPE Soft Front Panel (SFP) allows interactive control of the PXIe-5622.

Interactive control of the PXIe-5622 was first available in NI-SCOPE SFP version 3.5. The NI-SCOPE SFP is included on the NI-SCOPE media.

NI Measurement Automation Explorer (MAX) also provides interactive configuration and test tools for the PXIe-5622. MAX is included on the NI-SCOPE media.

Power

Maximum power consumption, at highest operating temperature		
+3.3 VDC	1.75 A	
+12 VDC	2.25 A	
Total power	32.8 W	

Physical Characteristics

Dimensions	21.6 cm × 2.0 cm × 13.0 cm (8.5 in. × 0.8 in. × 5.1 in.)	
	3U, one slot, PXI/cPCI Module, PXI Express compatible	
Weight	400 g (14.1 oz)	

Environment

Maximum altitude	2,000 m (800 mbar) (at 25 °C ambient temperature)
Pollution Degree	2

Indoor use only.

Operating Environment

Ambient temperature range	0 °C to 55 °C (Tested in accordance with IEC 60068-2-1 and IEC 60068-2-2. Meets MIL-PRF-28800F Class 3 low temperature limit and MIL-PRF-28800F Class 2 high temperature limit.)
Relative humidity range	10% to 90%, noncondensing (Tested in accordance with IEC 60068-2-56.)

Storage Environment

Ambient temperature range	-40 °C to 71 °C (Tested in accordance with IEC 60068-2-1 and IEC 60068-2-2. Meets MIL-PRF-28800F Class 3 limits.)
Relative humidity range	5% to 95%, noncondensing (Tested in accordance with IEC 60068-2-56.)

Shock and Vibration

Operating sh	ock	30 g peak, half-sine, 11 ms pulse (Tested in accordance with IEC 60068-2-27. Meets MIL-PRF-28800F Class 2 limits.)		
Random vibration				
Operating	5 Hz to 500 Hz, 0.3 g _{rms} (Tested in accordance with IEC 60068-2-64.)			

Nononerating 5 Hz to 500 Hz 2 4 g...... (Tested in accordance with IFC 60068-2-64 Test n

Nonoperating 5 Hz to 500 Hz, 2.4 g_{rms} (Tested in accordance with IEC 60068-2-64. Test profile exceeds the requirements of MIL-PRF-28800F, Class 3.)

Compliance and Certifications

Safety

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA C22.2 No. 61010-1

Note For UL and other safety certifications, refer to the product label or the Online Product Certification section.

Electromagnetic Compatibility

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- EN 55022 (CISPR 22): Class A emissions
- EN 55024 (CISPR 24): Immunity
- AS/NZS CISPR 11: Group 1, Class A emissions
- AS/NZS CISPR 22: Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions

Note In the United States (per FCC 47 CFR), Class A equipment is intended for use in commercial, light-industrial, and heavy-industrial locations. In Europe, Canada, Australia, and New Zealand (per CISPR 11), Class A equipment is intended for use only in heavy-industrial locations.

Note Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.

Note For EMC declarations, certifications, and additional information, refer to the Online Product Certification section.

CE Compliance C €

This product meets the essential requirements of applicable European Directives, as follows:

- 2014/35/EU; Low-Voltage Directive (safety)
- 2014/30/EU; Electromagnetic Compatibility Directive (EMC)

Online Product Certification

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for this product, visit <u>ni.com/certification</u>, search by model number or product line, and click the appropriate link in the Certification column.

Environmental Management

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the **Minimize Our Environmental Impact** web page at <u>ni.com/environment</u>. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

Waste Electrical and Electronic Equipment (WEEE)

EU Customers At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit ni.com/ environment/weee.

电子信息产品污染控制管理办法(中国 RoHS)

中国客户 National Instruments 符合中国电子信息产品中限制使用某 些有害物质指令(RoHS)。关于 National Instruments 中国 RoHS 合规性信 息,请登录 ni.com/environment/rohs_china。(For information about China RoHS compliance, go to ni.com/environment/rohs_china.)

- ¹ Dither enabled. Can overrange up to 3 dB with Dither disabled.
- 2 Valid over 23 °C ± 5 °C. Maximum drift of ± 2 °C from last self-calibration.
- 3 Valid over 23 $^{\circ}$ C \pm 5 $^{\circ}$ C. Maximum drift of \pm 2 $^{\circ}$ C from last self-calibration.
- ⁴ Dither is disabled by default in NI-SCOPE. To enable dithering, refer to the NI High-Speed Digitizers Help.
- ⁵ Equalization requires using the Digital Filter Design Toolkit to compute equalization filter coefficients. This software is not included with the NI-SCOPE driver.
- ⁶ +3 dBm total power at 1 V range, Dither ON
- ⁷ Verified using a 50 Ω terminator connected to input; valid for all filter paths.
- ⁸ Verified using a 50 Ω terminator connected to input; valid for all filter paths.
- 9 Refer to the **Onboard signal processing (OSP)** section for possible **N** values (with and without fractional resampling). Non-OSP decimation does not protect the

acquired data from undersampling aliasing. Non-OSP decimation and OSP decimation are mutually exclusive.

- $\frac{10}{2}$ Internal VCXO, unlocked.
- $\frac{11}{2}$ Refer to your chassis documentation to ensure it meets this requirement.
- $\frac{12}{12}$ For information about manual adjustment, refer to the **Synchronization Repeatability Optimization** topic in the **NI-TClk Synchronization Help**; for additional help with the adjustment process, contact NI technical support at $\frac{1}{12}$ ni.com/support.
- $\frac{13}{10}$ Assumes 2-byte samples. In Complex data processing mode (only available when using onboard signal processing), each sample is 4 bytes, so this number is halved.
- $\frac{14}{12}$ **Record length** refers to the number of samples, or data points, the NI-SCOPE device acquires for each channel in a single acquisition.
- $\frac{15}{1}$ It is possible to exceed this number if you fetch records while acquiring data. For more information, refer to the NI High-Speed Digitizers Help.
- $\frac{16}{10}$ Non-OSP decimation does not protect against high-frequency aliasing. Non-OSP decimation and OSP decimation are mutually exclusive.
- 17 For sample rates less than 9.155 kS/s, use an external sample clock or perform additional software decimation.
- $\frac{18}{2}$ Fractional resampling not available.
- $\frac{19}{2}$ Using a decimation rate of 1 (sample rate of 150 MS/s with internal clock) bypasses the filters in the OSP block.
- ²⁰ Gain <1 attenuates user data
- $\frac{21}{2}$ (-0.5 × Vertical Range) \leq Output \leq (+0.5 × Vertical Range)
- 22 Undersampling can be used for carrier frequencies >75 MHz.

- $\frac{23}{100}$ MSK modulation, 270.833 kSymbols/s, 1024 symbols, gaussian, BT = 0.3.
- ²⁴ In this case, the direct path carrier frequency is 35 MHz using the NI PXIe-5450 as the source.
- ²⁵ QPSK modulation, 3.84 MSymbols/s, 1024 symbols, root raised cosine, alpha = 0.22.
- 26 32 QAM modulation, 6.92 MSymbols/s, 1024 symbols, root raised cosine, alpha = 0.15.
- 27 64 QAM modulation, 20 MSymbols/s, 1024 symbols, root raised cosine, alpha = 0.15.
- ²⁸ 64 QAM modulation, 26.09 MSymbols/s, 1024 symbols, root raised cosine, alpha = 0.15.
- ²⁹ 64 QAM modulation, 34.78 MSymbols/s, 1024 symbols, root raised cosine, alpha = 0.15.